

## INVERTER GRADE THYRISTORS

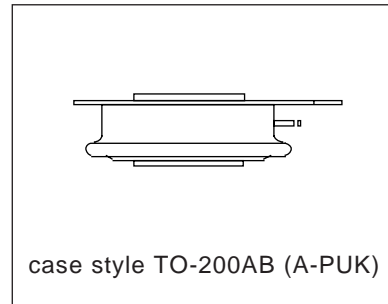
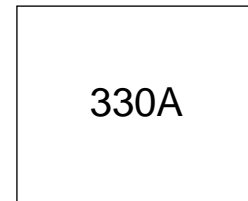
## Hockey Puk Version

### Features

- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high dI/dt
- High surge current capability
- Low thermal impedance
- High speed performance

### Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters



### Major Ratings and Characteristics

| Parameters        | ST173C..C      | Units             |
|-------------------|----------------|-------------------|
| $I_{T(AV)}$       | 330            | A                 |
| @ $T_{hs}$        | 55             | °C                |
| $I_{T(RMS)}$      | 610            | A                 |
| @ $T_{hs}$        | 25             | °C                |
| $I_{TSM}$         | @ 50Hz<br>4680 | A                 |
|                   | @ 60Hz<br>4900 | A                 |
| $I^2t$            | @ 50Hz<br>110  | KA <sup>2</sup> s |
|                   | @ 60Hz<br>100  | KA <sup>2</sup> s |
| $V_{DRM}/V_{RRM}$ | 1000 to 1200   | V                 |
| $t_q$ range       | 15 to 30       | μs                |
| $T_J$             | - 40 to 125    | °C                |

## ST173C..C Series

Bulletin I25180 rev. A 04/94

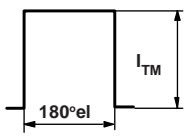
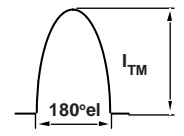
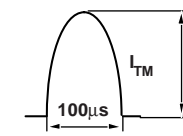
International  
 Rectifier

### ELECTRICAL SPECIFICATIONS

#### Voltage Ratings

| Type number | Voltage Code | $V_{DRM}/V_{RRM}$ , maximum repetitive peak voltage<br>V | $V_{RSM}$ , maximum non-repetitive peak voltage<br>V | $I_{DRM}/I_{RRM}$ max.<br>@ $T_J = T_J$ max.<br>mA |
|-------------|--------------|--|--|--|
| ST173C..C   | 10           | 1000   | 1100   | 40   |
|             | 12           | 1200   | 1300   |  |

#### Current Carrying Capability

| Frequency                        |  |     |  |      |  |      | Units |
|----------------------------------|---|-----|---|------|---|------|-------|
|                                  |   |     |   |      |   |      |       |
| 50Hz                             | 760   | 660 | 1200  | 1030 | 5570  | 4920 | A     |
| 400Hz                            | 730   | 590 | 1260  | 1080 | 2800  | 2460 |       |
| 1000Hz                           | 600   | 490 | 1200  | 1030 | 1620  | 1390 |       |
| 2500Hz                           | 350   | 270 | 850   | 720  | 800   | 680  |       |
| Recovery voltage Vr              | 50  | 50  | 50  | 50   | 50  | 50   | V     |
| Voltage before turn-on Vd        | $V_{DRM}$   |     | $V_{DRM}$   |      | $V_{DRM}$   |      |       |
| Rise of on-state current di/dt   | 50  | 50  | -   | -    | -   | -    | A/µs  |
| Heatsink temperature             | 40  | 55  | 40  | 55   | 40  | 55   | °C    |
| Equivalent values for RC circuit | 47Ω / 0.22µF  |     | 47Ω / 0.22µF  |      | 47Ω / 0.22µF  |      |       |

#### On-state Conduction

| Parameter   | ST173C..C | Units              | Conditions   |                       |
|---|-----------|--------------------|--|-----------------------|
| $I_{T(AV)}$ Max. average on-state current @ Heatsink temperature  | 330 (120) | A                  | 180° conduction, half sine wave double side (single side) cooled |                       |
|   | 55 (85)   | °C                 |  |                       |
| $I_{T(RMS)}$ Max. RMS on-state current                            | 610       | A                  | DC @ 25°C heatsink temperature double side cooled                |                       |
| $I_{TSM}$ Max. peak, one half cycle, non-repetitive surge current | 4680      |                    | t = 10ms   | No voltage reappplied |
|   | 4900      |                    | t = 8.3ms  | reappplied            |
|   | 3940      |                    | t = 10ms   | 100% $V_{RRM}$        |
| $I^2t$ Maximum $I^2t$ for fusing                                  | 4120      | t = 8.3ms          | reappplied   |                       |
|   | 110       | t = 10ms           | No voltage reappplied  |                       |
|   |           | t = 8.3ms          | reappplied   |                       |
|   | 100       | t = 10ms           | 100% $V_{RRM}$   |                       |
| 77  | t = 8.3ms | reappplied         |  |                       |
| 71  |           |                    |  |                       |
| $I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing                    | 1100      | KA <sup>2</sup> √s | t = 0.1 to 10ms, no voltage reappplied                           |                       |

**On-state Conduction**

| Parameter   | ST173C..C | Units      | Conditions  |
|---|-----------|------------|---|
| $V_{TM}$ Max. peak on-state voltage                   | 2.07      | V          | $I_{TM} = 600A, T_J = T_J \text{ max}, t_p = 10\text{ms}$ sine wave pulse                 |
| $V_{T(TO)1}$ Low level value of threshold voltage     | 1.55      |            | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$ |
| $V_{T(TO)2}$ High level value of threshold voltage    | 1.61      |            | $(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$                                      |
| $r_{t1}$ Low level value of forward slope resistance  | 0.87      | m $\Omega$ | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$ |
| $r_{t2}$ High level value of forward slope resistance | 0.77      |            | $(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$                                      |
| $I_H$ Maximum holding current                         | 600       | mA         | $T_J = 25^\circ\text{C}, I_T > 30A$   |
| $I_L$ Typical latching current                        | 1000      |            | $T_J = 25^\circ\text{C}, V_A = 12V, R_a = 6\Omega, I_G = 1A$                              |

**Switching**

| Parameter   | ST173C..C        | Units            | Conditions  |
|---|------------------|------------------|---|
| $di/dt$ Max. non-repetitive rate of rise of turned-on current | 1000             | A/ $\mu\text{s}$ | $T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$<br>$I_{TM} = 2 \times di/dt$   |
| $t_d$ Typical delay time                                      | 1.1              | $\mu\text{s}$    | $T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50A \text{ DC}, t_p = 1\mu\text{s}$<br>Resistive load, Gate pulse: 10V, 5 $\Omega$ source       |
| $t_q$ Max. turn-off time                                      | Min 15<br>Max 30 |                  | $T_J = T_J \text{ max}, I_{TM} = 300A, \text{commutating } di/dt = 20A/\mu\text{s}$<br>$V_R = 50V, t_p = 500\mu\text{s}, dv/dt: \text{ see table in device code}$ |

**Blocking**

| Parameter  | ST173C..C | Units            | Conditions  |
|--|-----------|------------------|---|
| $dv/dt$ Maximum critical rate of rise of off-state voltage             | 500       | V/ $\mu\text{s}$ | $T_J = T_J \text{ max. linear to } 80\% V_{DRM}, \text{ higher value available on request}$ |
| $I_{RRM}$<br>$I_{DRM}$ Max. peak reverse and off-state leakage current | 40        | mA               | $T_J = T_J \text{ max}, \text{rated } V_{DRM}/V_{RRM} \text{ applied}$                      |

**Triggering**

| Parameter   | ST173C..C | Units | Conditions   |
|---|-----------|-------|--|
| $P_{GM}$ Maximum peak gate power                  | 60        | W     | $T_J = T_J \text{ max}, f = 50\text{Hz}, d\% = 50$             |
| $P_{G(AV)}$ Maximum average gate power            | 10        |       |  |
| $I_{GM}$ Max. peak positive gate current          | 10        | A     | $T_J = T_J \text{ max}, t_p \leq 5\text{ms}$                   |
| $+V_{GM}$ Maximum peak positive gate voltage      | 20        | V     | $T_J = T_J \text{ max}, t_p \leq 5\text{ms}$                   |
| $-V_{GM}$ Maximum peak negative gate voltage      | 5         |       |  |
| $I_{GT}$ Max. DC gate current required to trigger | 200       | mA    | $T_J = 25^\circ\text{C}, V_A = 12V, R_a = 6\Omega$             |
| $V_{GT}$ Max. DC gate voltage required to trigger | 3         |       |  |
| $I_{GD}$ Max. DC gate current not to trigger      | 20        | mA    | $T_J = T_J \text{ max}, \text{rated } V_{DRM} \text{ applied}$ |
| $V_{GD}$ Max. DC gate voltage not to trigger      | 0.25      |       |  |

# ST173C..C Series

Bulletin I25180 rev. A 04/94

## Thermal and Mechanical Specification

| Parameter   | ST173C..C          | Units     | Conditions                      |
|---|--------------------|-----------|---------------------------------|
| T <sub>J</sub> Max. operating temperature range                   | -40 to 125         | °C        |                                 |
| T <sub>stg</sub> Max. storage temperature range                   | -40 to 150         |           |                                 |
| R <sub>thJ-hs</sub> Max. thermal resistance, junction to heatsink | 0.17               | K/W       | DC operation single side cooled |
|   | 0.08               |           | DC operation double side cooled |
| R <sub>thC-hs</sub> Max. thermal resistance, case to heatsink     | 0.033              | K/W       | DC operation single side cooled |
|   | 0.017              |           | DC operation double side cooled |
| F Mounting force, ± 10%   | 4900<br>(500)      | N<br>(Kg) |                                 |
| wt Approximate weight   | 50                 | g         |                                 |
| Case style  | TO - 200AB (A-PUK) |           | See Outline Table               |

## ΔR<sub>thJ-hs</sub> Conduction

(The following table shows the increment of thermal resistance R<sub>thJ-hs</sub> when devices operate at different conduction angles than DC)

| Conduction angle | Sinusoidal conduction |             | Rectangular conduction |             | Units | Conditions                           |
|------------------|-----------------------|-------------|------------------------|-------------|-------|--------------------------------------|
|                  | Single Side           | Double Side | Single Side            | Double Side |       |                                      |
| 180°             | 0.015                 | 0.016       | 0.011                  | 0.011       | K/W   | T <sub>J</sub> = T <sub>J</sub> max. |
| 120°             | 0.018                 | 0.019       | 0.019                  | 0.019       |       |                                      |
| 90°              | 0.024                 | 0.024       | 0.026                  | 0.026       |       |                                      |
| 60°              | 0.035                 | 0.035       | 0.036                  | 0.037       |       |                                      |
| 30°              | 0.060                 | 0.060       | 0.060                  | 0.061       |       |                                      |

## Ordering Information Table

**Device Code**

|    |    |   |   |    |   |   |   |   |   |
|----|----|---|---|----|---|---|---|---|---|
| ST | 17 | 3 | C | 12 | C | H | K | 1 |   |
| ①  | ②  | ③ | ④ | ⑤  | ⑥ | ⑦ | ⑧ | ⑨ | ⑩ |

- 1** - Thyristor
- 2** - Essential part number
- 3** - 3 = Fast turn off
- 4** - C = Ceramic Puk
- 5** - Voltage code: Code x 100 = V<sub>RRM</sub> (See Voltage Rating Table)
- 6** - C = Puk Case TO-200AB (A-PUK)
- 7** - Reapplied dv/dt code (for t<sub>q</sub> test condition)
- 8** - t<sub>q</sub> code
- 9** - 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads)
  - 1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads)
  - 2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads)
  - 3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads)
- 10** - Critical dv/dt:
  - None = 500V/μsec (Standard value)
  - L = 1000V/μsec (Special selection)

| dv/dt - t <sub>q</sub> combinations available |    |    |     |             |     |
|---|----|----|-----|-------------|-----|
| dv/dt (V/μs)                                  | 20 | 50 | 100 | 200         | 400 |
| 15  | CL | -- | --  | --          | --  |
| 18  | CP | DP | EP  | <b>FP</b> * | --  |
| 20  | CK | DK | EK  | <b>FK</b> * | HK  |
| 25  | CJ | DJ | EJ  | FJ          | HJ  |
| 30  | -- | DH | EH  | FH          | HH  |

\*Standard part number.  
All other types available only on request.

Outline Table

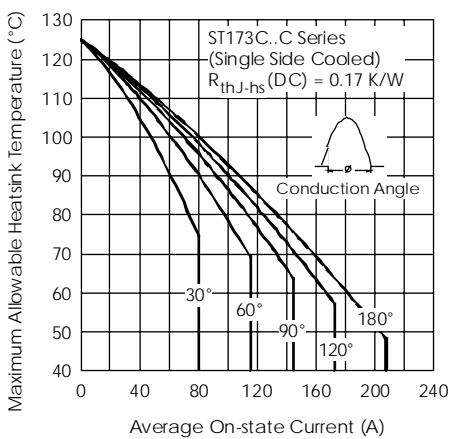
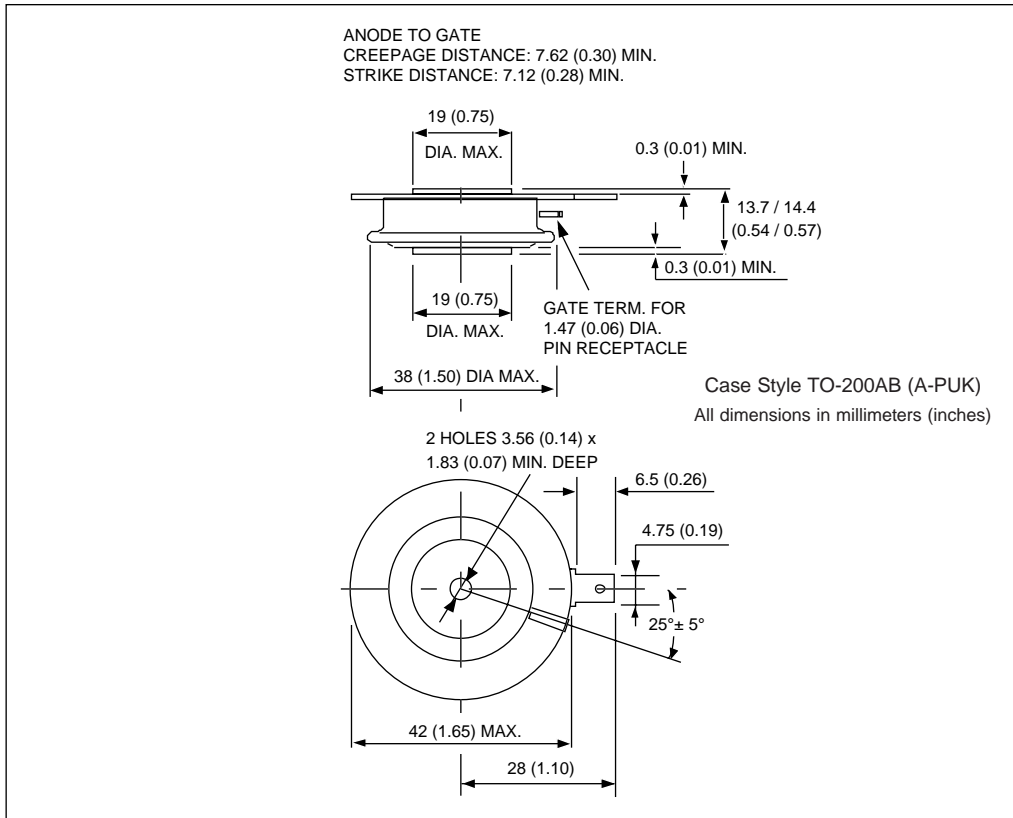


Fig. 1 - Current Ratings Characteristics

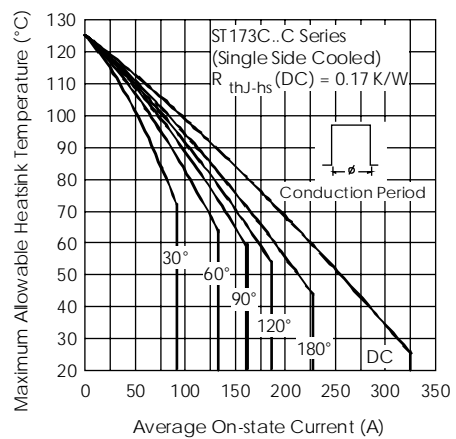


Fig. 2 - Current Ratings Characteristics

# ST173C..C Series

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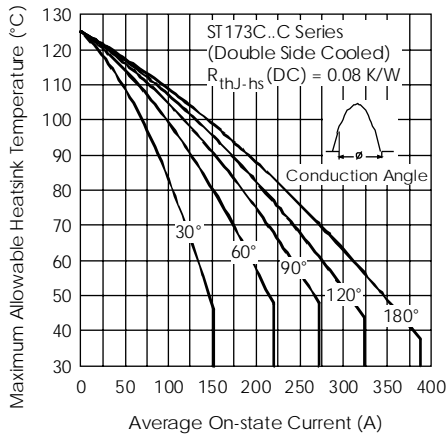


Fig. 3 - Current Ratings Characteristics

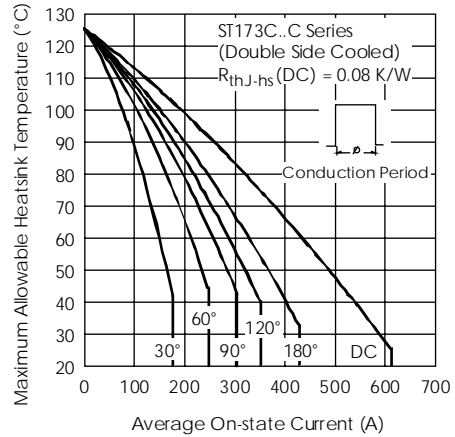


Fig. 4 - Current Ratings Characteristics

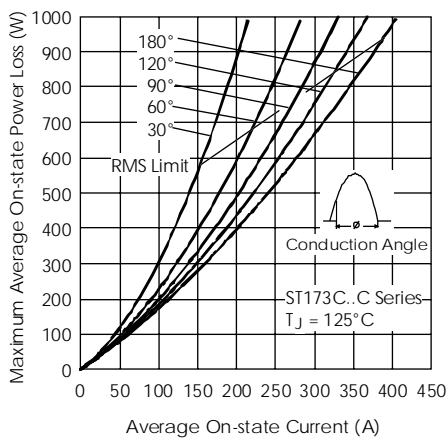


Fig. 5 - On-state Power Loss Characteristics

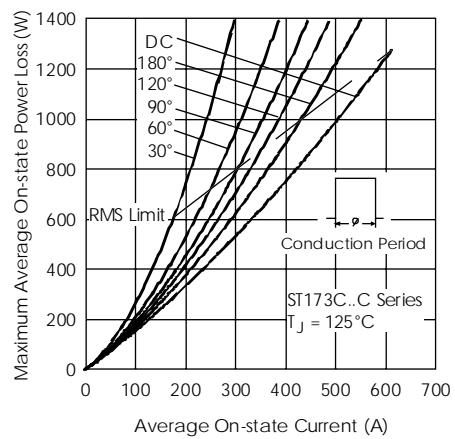


Fig. 6 - On-state Power Loss Characteristics

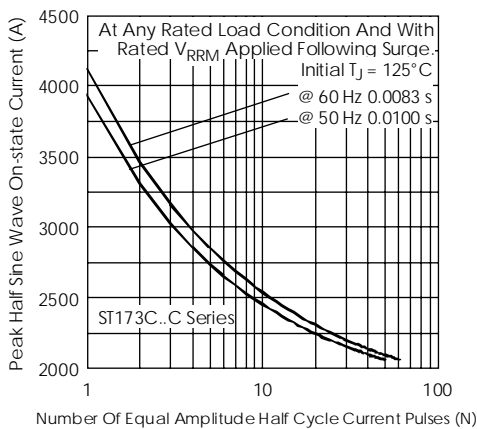


Fig. 7 - Maximum Non-repetitive Surge Current Single and Double Side Cooled

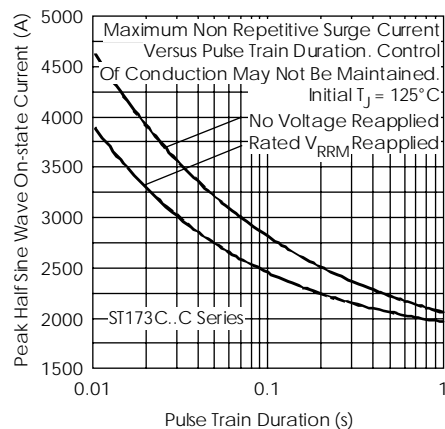


Fig. 8 - Maximum Non-repetitive Surge Current Single and Double Side Cooled

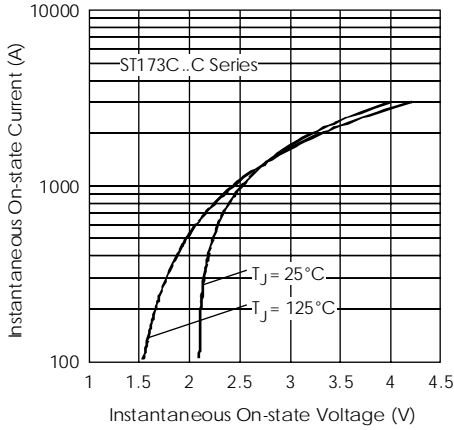


Fig. 9 - On-state Voltage Drop Characteristics

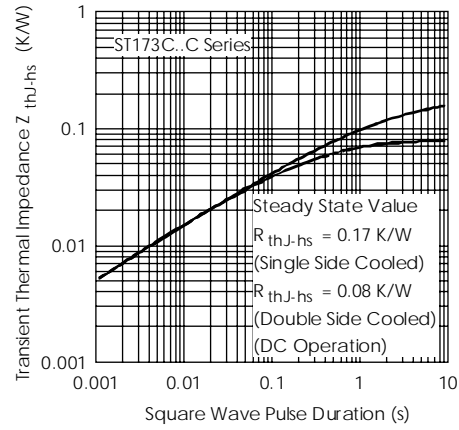


Fig. 10 - Thermal Impedance  $Z_{thJ-hs}$  Characteristics

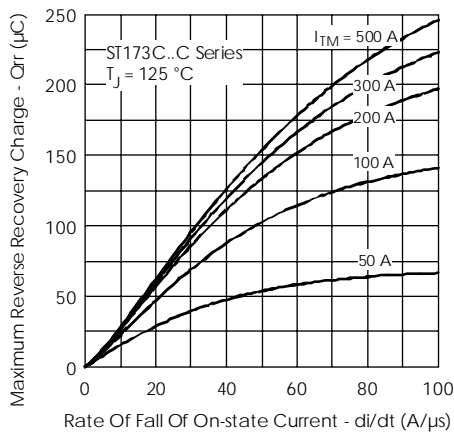


Fig. 11 - Reverse Recovered Charge Characteristics

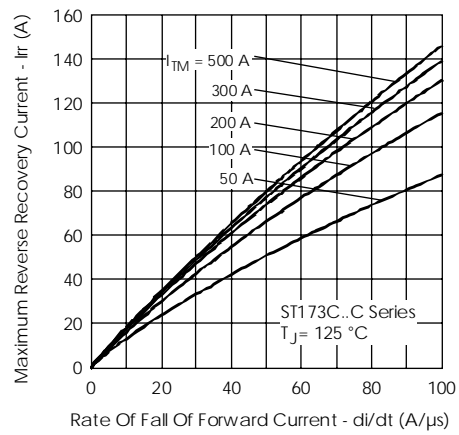


Fig. 12 - Reverse Recovery Current Characteristics

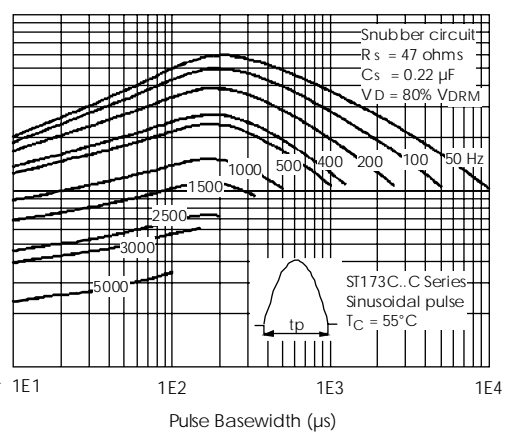
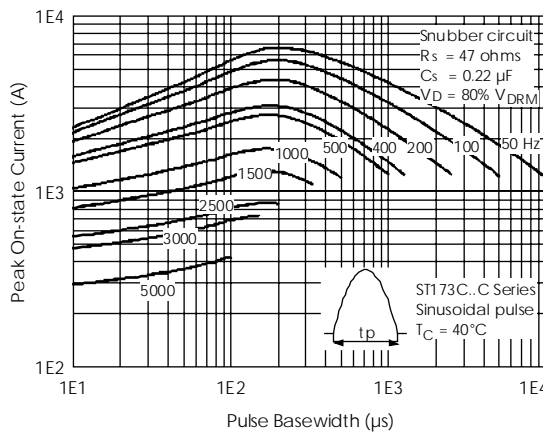


Fig. 13 - Frequency Characteristics

# ST173C..C Series

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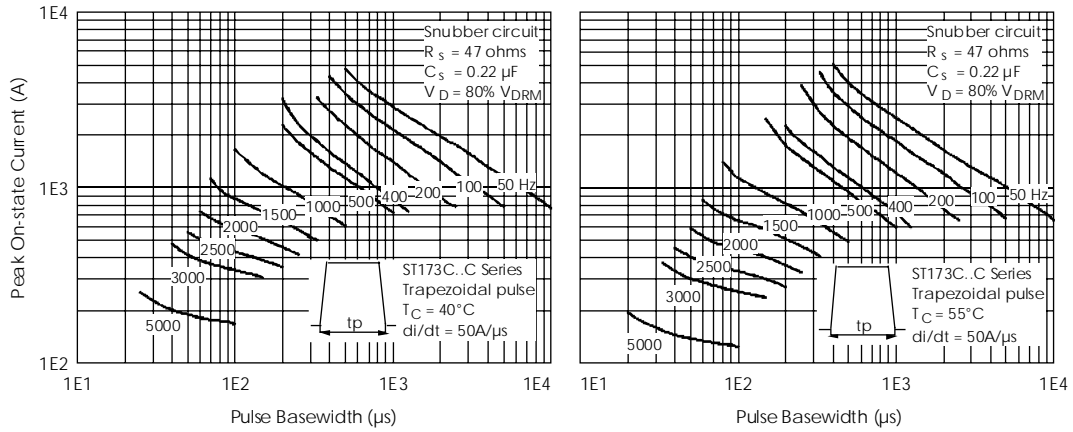


Fig. 14 - Frequency Characteristics

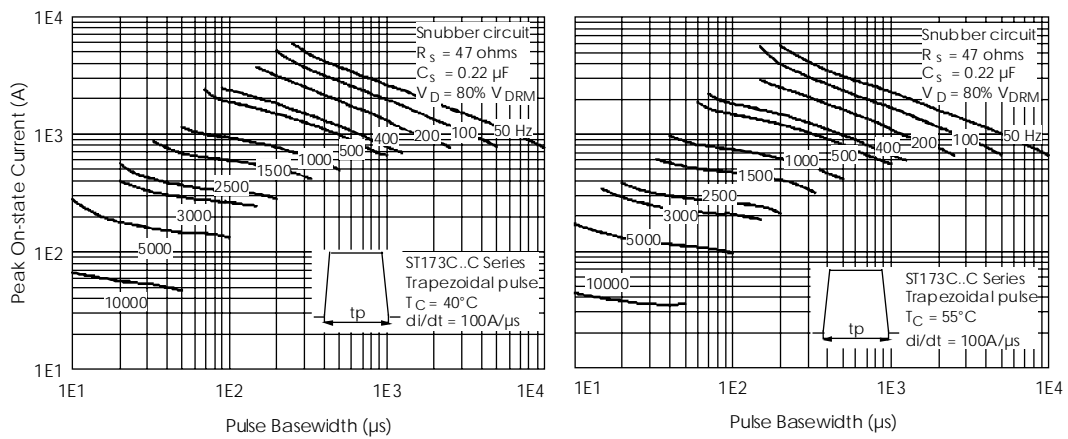


Fig. 15 - Frequency Characteristics

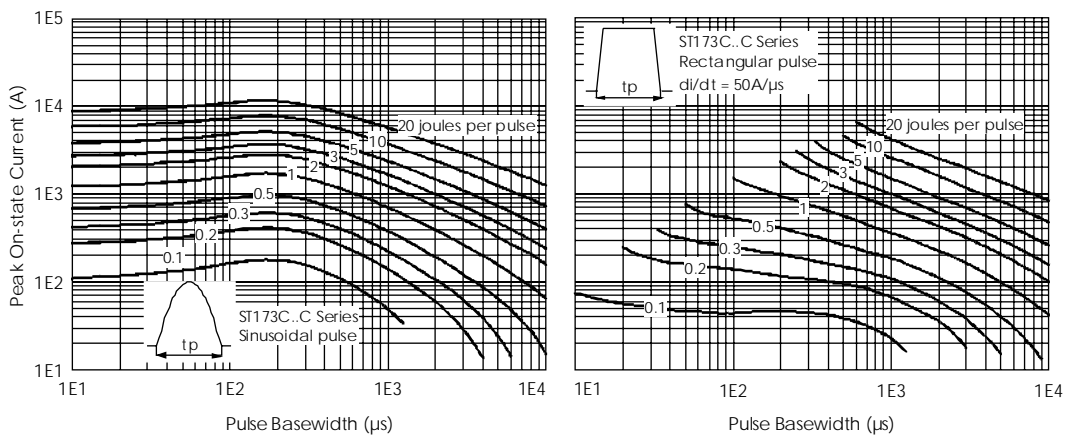


Fig. 16 - Maximum On-state Energy Power Loss Characteristics



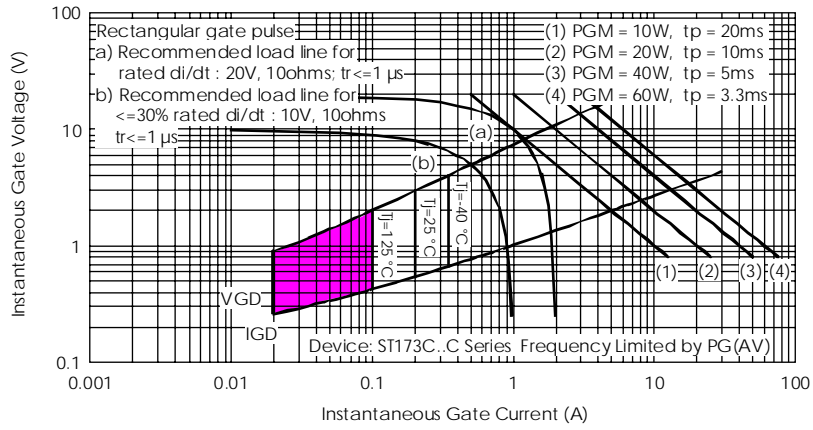


Fig. 17 - Gate Characteristics